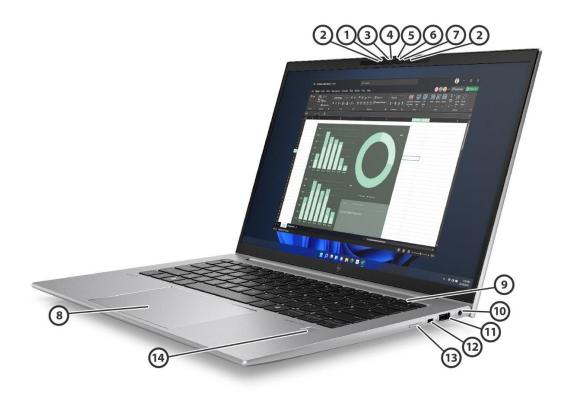
Overview

HP ZBook Firefly 14" G11 Mobile Workstation PC



- 1. Ambient Light Sensor (Optional)
- 2. Internal Microphones (2)
- 3. Webcam LED (Optional)
- 4. Webcam
- 5. Camera Shutter
- 6. IR Camera (Optional)
- 7. IR Camera LEDs (Optional)

Right

- 8. Glass Clickpad
- 9. Power Button Key
- 10. Audio Combo Jack
- 11. SuperSpeed USB Type-A 5Gbps signaling rate (Charging)
- 12. Nano Security Lock Slot (Lock sold separately)
- 13. Nano SIM Card Slot (Optional)
- 14. Touch Fingerprint Sensor (Select models)



Overview



Left

- 1. HDMI 2.1b Port (Cable not included)
- 2. SuperSpeed USB Type-A 5Gbps signaling rate
- 3. Thunderbolt[™] 4* with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)1
- *SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.
- 4. Thunderbolt™ 4* with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)1
- 5. LED Indicator
- 6. Smartcard Reader (Optional)



Overview



Bottom

1. Fan Venting



Overview

At A Glance

- Premium ultraslim design with precision-crafted all-metal chassis for a premium look and feel
- Intel® Core™ Ultra5, Ultra7 U series and Intel Core Ultra5, Ultra7 H series Processors up to fourteen-core
- Preinstalled with Windows 11 versions or FreeDOS
- Now available paired with Intel Core Ultra5/Ultra7 H series processors and discrete graphics
- 16:10 ratio screen reduces the need to scroll by showing more vertical content than 16:9
- 5MP camera with 88° field of view allows you to move around more freely in front on the camera or accommodate a group
- DDR5-5600 memory with up to 64GB capacity
- Choice of displays:
 - 35.6 cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit, 300 nits, 45% NTSC
 - 35.6cm (14") diagonal WUXGA IPS Anti-Glare On-Cell LED-backlit touch, 300 nits, 45% NTSC
 - o 35.6 cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit non-touch 400 nits, 100% sRGB
 - 35.6cm (14") diagonal WUXGA IPS Anti-Glare LED-backlit non-touch, 1000 nits, 100% sRGB with HP Sure View Reflect
 - 35.6cm (14") diagonal WQXGA IPS Anti-Glare LED-backlit non-touch, 500 nits, 100% DCI-P3, DreamColor
- Optional NVIDIA RTX A500 pro graphics for improved performance for heavier graphics workloads.
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense.
- Optional 14" DreamColor display for complete color accuracy with a 120Hz refresh rate for smooth motion.
- Connectivity with optional HP 5G/WWAN available world-wide, and Thunderbolt™ Docking (Dock sold separately)
- Undergoes MIL-STD 810H tests1
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support all HP docking options including the HP Universal Dock G5

¹MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

OPERATING SYSTEM

Preinstalled OS Windows 11 Home 64 - HP recommends Windows 11 Pro for business¹

Windows 11 Home Single Language 64 - HP recommends Windows 11 Pro for business1

Windows 11 Pro 64(Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing

Agreement)¹ Windows 11 Pro¹ FreeDOS 3.0

¹ Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

PROCESSOR

Name ^{1,2,3,4,5,7}	Cores	Number of P-cores		Number Of LP E-core	Threads	L3 Cache	Max Turbo Frequency		Intel
							P-cores	E-cores	SIPP/vPro® Enterprise
Intel® Core™ Ultra 7 processor 165H	16 cores	6	8	2	22	24 MB	5.00 GHz	3.80 GHz	Х
Intel® Core™ Ultra 7 processor 155H	16 cores	6	8	2	22	24 MB	4.80 Ghz	3.80 GHz	
Intel® Core™ Ultra 5 processor 135H	14 cores	4	8	2	18	18 MB	4.60 GHz	3.60 GHz	х
Intel® Core™ Ultra 5 processor 125H	14 cores	4	8	2	18	18 MB	4.50 GHz	3.60 GHz	
Intel® Core™ Ultra 7 processor 165U	12 cores	2	8	2	14	12 MB	4.90 GHz	3.80 GHz	х
Intel® Core™ Ultra 7 processor 155U	12 cores	2	8	2	14	12 MB	4.80 GHz	3.80 GHz	
Intel® Core™ Ultra 5 processor 135U	12 cores	2	8	2	14	12 MB	4.40 Ghz	3.60 GHz	Х
Intel® Core™ Ultra 5 processor 125U	12 cores	2	8	2	14	12 MB	4.30 Ghz	3.60 GHz	



Features

¹ Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

² Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

³ Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

⁴In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

⁵ Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

⁷Features and software that require a NPU may require software purchase, subscription or enablement by a software or platform provider, and third party software may have specific configuration or compatibility requirements. Performance varies by use, configuration, and other factors.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Arc™ GPU (H Series processors)

Intel® Graphics (U Series processors)

Discrete

NVIDIA RTX™ A500 Laptop GPU (4 GB GDDR6 dedicated)^{1,2}

Supports

Support HD decode, DX12, HDMI 2.1b, HDCP 2.3

¹ Both UMA & Discrete configurations support 4 independent displays when on the HP Thunderbolt Dock G4 (120W) (sold separately) - Max. resolution = 2.5K @60Hz (DP1) & 2.5K @60Hz (DP2) & FHD (VGA) OR 4K @60Hz (one DP Port) & 4K @60Hz (Type-C output port using a Type C-to-DP adapter).

² HDMI cable Sold Separately

DISPLAY

Non-touch

35.6 cm (14") diagonal, WUXGA (1920 x 1200), Bent, LCD, UWVA, anti-glare, WLED + Low Blue Light, 1000 nits, sRGB 100%, HP Sure View reflect integrated privacy screen^{1,3,4,5}



Features

- 35.6 cm (14") diagonal, WQXGA (2560 x 1600), Bent, LCD, 120Hz, UWVA, anti-glare, WLED, 500 nits, DCI-P3 100%, HP DreamColor^{1,3}
- 35.6 cm (14") diagonal, WUXGA (1920 x 1200), Bent, LCD, UWVA, anti-glare, WLED + Low Blue Light, 400 nits, low power, sRGB 100%^{1,3}
- 35.6 cm (14") diagonal, WUXGA (1920 x 1200), Bent, LCD, UWVA, anti-qlare, WLED, 300 nits, NTSC 45%^{1,3}

Touch

35.6 cm (14") diagonal, WUXGA (1920 x 1200), Bent, LCD, touch, anti-glare, WLED, 300 nits, NTSC 45%^{1,3,4,5}

Displays support

Supports dual display through the dock

For more information, please reference the following ZBook docking whitepaper:

https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA5-2657ENW

Display Size

14"

35.56 cm (14")

¹HD content required to view HD images.

³Resolutions are dependent upon monitor capability, and resolution and color depth settings.

⁴HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

⁵Actual brightness will be lower with touchscreen or Sure View.



Features

DOCKING

Docking station model #1 HP Thunderbolt 120W G4 Dock

Total number of supported displays (incl.the notebook) display)

4

Max.resolutions supported

Quad 4K @60Hz Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in

high res mode

Dock Connectors

2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode

Technical limitations

Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host. Max resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a

non-Thunderbolt host in High Resolution mode @30Hz

Non-Thunderbolt hosts:

The highest resolution for dual displays running a non-Thunderbolt host in multi-function

mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port

Non-Thunderbolt hosts support (3) displays with a max resolution of: (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.

Docking station model #2

HP USB-C Dock G5

Total number of supported displays (incl.the notebook) display)

3

Max.resolutions supported

Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode)

Dock Connectors

1xHDMI, 2xDP

Technical limitations

Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode. Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30

Hz on HDMI in multi-function mode

HP USB-C/A Universal Dock G2

The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual

cable (using both DP ports) + (1) 4K on HDMI port.

Docking station model #3

Total number of supported displays (incl.the notebook) display)

3

Max.resolutions supported

Triple 4K UHD@ 60Hz

Dock Connectors

1xHDMI, 2xDP

Technical limitations

The best resolution for dual or triple displays is 4K UHD@ 60Hz.

For use with the USB-A adapter that comes in the box the maximum number of displays

supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host



Features

STORAGE AND DRIVES*

PCIe® NVMe™ M.2 2280 Storage

2 TB PCIe® Gen4x4 NVMe™ SSD Three Layer Cell
1 TB PCIe® Gen4x4 NVMe™ SSD Three Layer Cell
1 TB PCIe® NVMe™ SSD Value
512 GB PCIe® Gen4x4 NVMe™ Seld Encrypted OPAL2 SSD Three Layer Cell
512 GB PCIe® Gen4x4 NVMe™ SSD Three Layer Cell
512 GB PCIe® NVMe™ SSD Value
256 GB PCIe® NVMe™ Seld Encrypted OPAL2 SSD Value
256 GB PCIe® NVMe™ SSD Value

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of disk is reserved for system recovery software.

MEMORY

Maximum Memory

64GB DDR5-5600

Memory

64GB DDR5-5600 (2x32GB) 32GB DDR5-5600 (2x16GB) 32GB DDR5-5600 (1x32GB) 16GB DDR5-5600 (2x8GB) 16GB DDR5-5600 (1x16GB) 8GB DDR5-5600 (1x8GB)

Memory Slots

2 SODIMM DDR5 SODIMMS, system runs at 5600 Supports Dual Channel Memory

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



Features

NETWORKING/COMMUNICATIONS

WLAN

Intel® AX211 Wi-Fi 6E Bluetooth® 5.3 wireless card vPro WLAN^{1,2} Intel® AX211 Wi-Fi 6E Bluetooth® 5.3 wireless card WLAN¹

¹Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, and Windows 11 to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

² Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

WWAN

HP 5G Sub-6 Cat 19 WWAN eSIM^{1,2} HP 4G LTE-A Pro Cat 16 WWAN eSIM¹

¹WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

²5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

LPWAN

Qualcomm® 9205

Near Field Communication (NFC) module

NFC NXP NPC3001

¹Sold separately or as an optional feature.

Miracast

Native Miracast Support

NOTE: Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

Audio Tuning by Poly Studio
2 Integrated stereo speakers
Discrete Amplifiers
2 Integrated dual array microphone
3.5mm Headset: CTIA only; Headphone-out

Speaker Power

1W/8ohm Per speaker



Features

Camera¹

5MP+Infrared camera 5MP camera

Sensors

ALS (ambient light sensor)
ACS (Adaptive Color Sensor)
Hall effect Sensor
Thermal Sensor
HP Tamper Lock²



¹ Sold separately or as an optional feature.

² HP Tamper Lock must be enabled by the customer or your administrator.

Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard*

HP Premium Keyboard, spill-resistant, Privacy, Backlit, Durakey keyboard.

HP Premium Keyboard, spill-resistant, Backlit, Durakey keyboard.

HP Premium Keyboard, spill-resistant, Durakey keyboard.

Pointing Devices

Clickpad with multi-touch gesture support Microsoft Precision Touchpad Default Gestures Support Multi-touch gesture support

Function Keys

ESC: system information

F1 - Display Switching

F2 - Blank or Privacy

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Insert

F11 - Airplane Mode

F12 - HP Command Center

home

end

Power Button (with LED)

Delete

Microsoft Copilot key**

Hidden Keys

Fn+R - Break

Fn+S - Svs Ra

Fn+C - Scroll Lock

SOFTWARE AND SECURITY

Software

Bing Search for IE11

Buy Microsoft Office (Sold separately)

HP Connection Optimizer¹⁰

HP Easy Clean²

HP Easy Clean Keyboard Driver²

HP Hotkey Support

HP Mac Address Manager

HP Notifications

HP PC Hardware Diagnostics UEFI

HP PC Hardware Diagnostics Windows

HP Privacy Settings

HP Support Assistant¹



^{*}Backlit keyboard is an optional feature.

^{**}Requires Windows 11 and an NPU. Timing of feature delivery and availability varies by market and device. Requires Microsoft account to log in. Where Copilot in Windows is not available, the Copilot key will lead to the Bing search engine. See http://aka.ms/WindowsAIFeatures

Features

HSA Fusion for Commercial HPX for CMIT

Manageability Features

HP Client Catalog (download)

HP Client Management Script Library (download)

HP Cloud Recovery²⁸

HP Connect for Microsoft Endpoint Manager²⁶

HP Driver Packs (download)

HP Image Assistant Gen5 (download)

HP Manageability Integration Kit (download)12

HP Patch Assistant (download)27

Security Management

HP Wolf Security of Business²⁹ includes:

HP Client Catalog (download)

HP Client Management Script Library (download)

HP Cloud Recovery²⁸

HP Connect for Microsoft Endpoint Manager²⁶

HP Driver Packs (download)

HP Image Assistant Gen5 (download)

HP Manageability Integration Kit (download)12

HP Patch Assistant (download)27

Security-TPM

TCG TPM 2.0

BIOS

Absolute Persistence Module⁷

BIOS Update via Network

HP BIOSphere Gen66

HP DriveLock & Automatic DriveLock

HP Fingerprint Sensor³²

HP Secure Erase¹⁷

HP Wake on WLAN

²HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions.

⁶ HP BIOSphere Gen6 is available on select HP Pro, Elite and ZBook PCs. See product specifications for details. Features may vary depending on the platform and configurations.

⁷ Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

¹⁰ HP Connection Optimizer requires Windows 10 and Windows 11.

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

Configuration Manager. HP Manageability Integration Kit can be downloaded from



¹ HP Support Assistant - Requires Windows and Internet Access.

¹² HP Manageability Integration Kit can be downloaded from https://ftp.ext.hp.com/pub/caps-softpag/cmit/HPMIK.html.

¹⁷ HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

²⁶ HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.

²⁷ HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center

Features

²⁸ HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. **NOTE:** You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: https://support.hp.com/us-en/document/c05115630.

²⁹ HP Wolf Security for Business requires Windows 10 Pro or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

³² HP Fingerprint Reader is an optional feature that requires Windows 10 IoT and must be configured at purchase.



Features

POWER

Power Supply

HP Standard 65W USB Type-C® adapter² HP Slim 65W USB Type-C® adapter² HP Slim 100W USB Type-C® AC adapter^{2,5}

Batterv

HP Long Life 3-cell, 56 Whr Polymer^{3,4}

Power Cord

3-wire plug - 1m 2-wire plug - 1m

Battery life

UMA1

Up to 15 hours and 15 minutes with 56whr battery (HP Long Life 3-Cell, 56 Whr Polymer, UMA graphic, Intel Ultra 7 U15 vPro, Display set to 250 nits display (on a 400-nit display), 2*8G LPDDR5 memory, 256 GB SSD)

Up to 14 hours with 56whr battery (HP Long Life 3-Cell, 56 Whr Polymer, UMA graphic, Intel Ultra 7 H28 vPro, Display set to 250 nits display (on a 400-nit display), 2*8G LPDDR5 memory, 256 GB SSD)

Discrete1

Up to 9 hours and 45 minutes with 56whr battery (HP Long Life 3-Cell, 56 Whr Polymer, NVIDIA RTX A500 graphics, Intel Ultra 7 H28 vPro, Display set to 250 nits display (on a 400-nit display), 2*8G LPDDR5 memory, 256 GB SSD)

- ¹ MM25 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.
- ² Availability may vary by country.
- ³Battery is internal and not replaceable by customer. Serviceable by warranty.
- ⁴ Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
- ⁵ The 100w AC adapter is required when discrete graphics are used.



Features

WEIGHTS & DIMENSIONS

Dimensions (w x d x h) 12.42 x 8.82 x 0.76 in 31.56 x 22.435 x 1.92 cm

Weights*
Product Weight- 56Whr
Starting at 3.13 lb
Starting at 1.418 kg

*Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

Left side

2 Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) *

1 HDMI 2.1**

1 Super Speed USB Type-A 5Gbps signaling rate

1 Smartcard reader

Right side

1 Headphone/microphone combo jack

1 Nano SIM card slot

1 Super Speed USB Type-A 5Gbps signaling rate

1 Security Lock Slot

*SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

**HDMI cable sold separately.

SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty.. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.

¹HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

Certification and Compliance

CSA/UL 62368-1 ENERGY STAR® FCC/ICES/CISPR/VCCI CE MARKING GS Mark



Features

China CCC/SRRC
Taiwan BSMI/NCC
Korea KCC/KC/KES
Ukraine NSoC/TEC
EAEU Compliance
Saudi Arabian Compliance
TCO
EPEAT® registered*
Low Blue Light
WW RoHS

Sustainable Impact Specifications

Low Halogen** aligned with HP GSE

*Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information

SYSTEM UNIT

JIJIENOMII		
Stand-Alone Power Requirements (AC Power)	Nominal Operating Voltage	AC 20V
	Average Operating Power(idle)	
	Integrated graphics	Yes
	Discrete Graphics	N/A
	Max Operating Power	65W
Temperature	Operating	32° to 95° F (0° to 35° C)
	Non-operating	-4° to 140° F (-20° to 60° C)
Relative Humidity	Operating	10% to 90%, non-condensing
	Non-operating	5% to 95% (38.7° C (101.6° F) maximum wet bulb tempera-ture; non-condensing)
Shock	Operating	40 G, 2 ms, half-sine
	Non-operating	240 G, 2 ms, half-sine
Random Vibration	Operating	1.043 grms
	Non-operating	3.5 grms
Maximum Altitude	Operating	10,000 ft (3,048 m)
(unpressurized)	Non-operating	40,000 ft (12,192 m)
Planned Industry Standard Certifications	Regulatory Model Number	HSN-145C-4
	CSA/UL 62368-1	Yes
	ENERGY STAR®1	Yes
	FCC/ICES/CISPR/VCCI	Yes
	CE MARKING	Yes
	GS Mark	Yes
	China CCC/SRRC	Yes
	Taiwan BSMI/NCC	Yes



Yes

Korea KCC/KC/KES

^{**}External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

Features

Ukraine NSoC/TEC Yes **EAEU Compliance** Yes Saudi Arabian Compliance Yes TC0

EPEAT® EPEAT® Gold in the United States²

Yes

Low Blue Light Yes **WW RoHS** Yes

Saudi Arabian

Compliance (ICCP) Yes **SABS** Yes



¹Configurations of the HP ZBook Firefly 14" G11 Mobile Workstation PC that are ENERGY STAR® qualified are identified as HP ZBook Firefly 14" G11 Mobile Workstation PC ENERGY STAR on HP websites and on http://www.energystar.gov.

² Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit www.epeat.net for more information.

Technical Specifications – Displays

DISPLAYS

14 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC 45 NB2X 300 eDP 1.2 w/o PSR bent LCD Panel

 Outline Dimensions (W x H)
 307.29 x 199.25 (max)

 Active Area
 301.59 X 188.50 (typ)

Weight 300 (max)

Diagonal Size 14

Thickness 3.0 / 4.8 (max)
Interface eDP 1.2
Surface Treatment Anti-Glare

Touch enabled No

Contrast Ratio1000:1(typ)Refresh Rate60 HzBrightness300 nits

Pixel Resolution Pitch 1920 x 1200 (WUXGA)

Format RGB

BacklightWLEDColor Gamut CoverageNTSC 45%Color Depth6+2 FRC

Viewing Angle UWVA 89/89/89

Low Blue Light No

Power Consumption (W, EBL@ 150nits max/ 200nits

max) 2.20 (max) / 2.70 (max)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC 45 NB2X 300 TOP eDP 1.2 w/o PSR bent LCD Panel

 Outline Dimensions (W x H)
 307.29 x 199.25 (max)

 Active Area
 301.59 x 188.50 (typ)

Weight 305g (max)

Diagonal Size 14

Thickness 3.0 / 5.0 (max)
Interface eDP 1.2
Surface Treatment Anti-Glare

Touch enabled Yes

Contrast Ratio1000:1(typ)Refresh Rate60 HzBrightness300 nits

Pixel Resolution Pitch 1920 x 1200 (WUXGA)

Format RGB

BacklightWLEDColor Gamut CoverageNTSC 45%Color Depth6+2 FRC

Viewing Angle UWVA 89/89/89

Low Blue Light No



Technical Specifications – Displays

Power Consumption (W, EBL@ 150nits max/ 200nits

2.15 (max)/2.65 (max)

max)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2X 400 eDP 1.4+PSR2 Low-Power 100 bent LCD Panel

 Outline Dimensions (W x H)
 307.590 x 199.550 (max)

 Active Area
 301.590 X 188.500 (typ)

Weight 210 (max)

Diagonal Size 14

Thickness 2.0 / 3.8 (max)

InterfaceeDP 1.4Surface TreatmentAnti-Glare

Touch enabled No

Contrast Ratio1000:1(typ)Refresh Rate60 HzBrightness400 nits

Pixel Resolution Pitch 1920 x 1200 (WUXGA)

Format RGB

Backlight WLED

Color Gamut Coverage sRGB 100%

Color Depth 8 bits

Viewing Angle UWVA 89/89/89

Low Blue Light Yes

Power Consumption (W, 1.29 (max) / 1.66 (max)

EBL@ 150nits max/ 200nits

max)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD Panel

 Outline Dimensions (W x H)
 307.600 x 199.550 (typ)

 Active Area
 301.680 x 188.500 (typ)

Weight 238 (max)

Diagonal Size 14

Thickness 2.2 / 3.9 (max)

Interface eDP 1.3
Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio1500:1(typ)Refresh Rate60 HzBrightness1000 nits

Pixel Resolution Pitch 1920 x 1200 (WUXGA)

Format RGB



Technical Specifications – Displays

Backlight WLED

Color Gamut Coverage sRGB 100%

Color Depth 8 bits

Viewing Angle UWVA 85/85/85

Low Blue Light Yes

Power Consumption (W, N/A

EBL@ 150nits max/ 200nits

max)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

14 in WQXGA DRM (2560 x 1600) Anti-Glare UWVA LED DCI-P3 NB2X 500 eDP 1.4+PSR2 100 120Hz bent LCD Panel

14 in WQXGA DRM (2560 x Outline Dimensions (W x H) 307.594 x 199.546 (max)

Active Area 301.594 x 188.496 (typ)

Weight 230 (max)

Diagonal Size 14

Thickness 2.0 / 3.8 (max)

Interface eDP 1.4
Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio1200:1(typ)Refresh Rate120 HzBrightness500 nits

Pixel Resolution Pitch 2560 x1600 (WQXGA)

Format RGB

Backlight WLED

Color Gamut Coverage DCI-P3 100%

Color Depth 8 bits

Viewing Angle UWVA 89/89/89

Low Blue Light No

Power Consumption (W, 2.88 (max) / 3.44 (max)

EBL@ 150nits max/ 200nits

max)

*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.



Technical Specifications – Storage

STORAGE AND DRIVES

SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

Performance Minimum Sequential Read Minimum Sequential Write

6400 MB/s ±20% 3500 MB/s ±20%

Logical Blocks 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 11) is reserved for

system recovery software.

SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 1TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

Performance Minimum Sequential Read Minimum Sequential Write

6400 MB/s ±20% 5000 MB/s ±20%

Logical Blocks 2,000,409,264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 11) is reserved for

system recovery software.

SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 2TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

Performance Minimum Sequential Read Minimum Sequential Write

6400 MB/s ±20% 5000 MB/s ±20%

Logical Blocks 4,000,797,360

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

Technical Specifications – Storage

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 11) is reserved for

system recovery software.

256GB PCIe 2280 NVMe Self Encrypted OPAL2 Value Solid State Drive Form Factor M.2 2280
Capacity 256GB
NAND Type TLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Weight 0.02 lb (10 g)
Interface PCIe NVMe Gen4X4

Performance Minimum Sequential Read Minimum Sequential Write

2000 MB/s ±20% 900 MB/s ±20%

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 11) is reserved for

system recovery software.

512GB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

Performance Minimum Sequential Read Minimum Sequential Write

6400 MB/s ±20% 3500 MB/s ±20%

Logical Blocks 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 11) is reserved for

system recovery software.

SSD 1TB 2280 PCIe NVMe Form Factor Value Capacity

Form Factor M.2 2280
Capacity 1TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

Performance Minimum Sequential Read Minimum Sequential Write

2200 MB/s ±20% 1600 MB/s ±20%

Logical Blocks 2,000,409,264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

Technical Specifications – Storage

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 11) is reserved for

system recovery software.

SSD 256GB 2280 PCIe NVMe Value Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

Performance Minimum Sequential Read Minimum Sequential Write

2000 MB/s ±20% 900 MB/s ±20%

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 11) is reserved for

system recovery software.

SSD 512GB 2280 PCIe NVMe Value Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

Performance Minimum Sequential Read Minimum Sequential Write

2200 MB/s ±20% 1000 MB/s ±20%

Logical Blocks 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35 GB (for Windows 11) is reserved for

system recovery software.

Technical Specifications – Networking

NETWORKING/COMMUNICATION

Intel® AX211 Wi-Fi 6E +Bluetooth® 5.3 wireless card M.2 160MHz CNVi World-wide WLAN vPro® 1	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11d IEEE 802.11t IEEE 802.11t IEEE 802.11t IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n/ax • 2.402 – 2.482 GHz 802.11a/n/ac/ax • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz • 5.955 – 6.415 GHz • 6.435 – 6.515 GHz • 6.535 – 6.875 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: max 300Mbps 802.11ac: 1733Mbps 802.11ax: max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum
	Security ¹	OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g
	Security	mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • WPA3 certification • IEEE 802.11i • WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
		initustructure (Access rount Nequileu)



Roaming

IEEE 802.11 compliant roaming between access points

Technical Specifications - Networking

• 802.11b: +17dBm minimum • 802.11g: +16dBm minimum • 802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
802.11n HT40(2.4GHz): +13dBm minimum
802.11n HT20(5GHz): +14dBm minimum
802.11n HT40(5GHz): +13dBm minimum
802.11ac VHT80(5GHz): +10dBm minimum
802.11ac VHT160(5GHz): +10dBm minimum
802.11ax HE40(2.4GHz): +12dBm minimum
802.11ax HE80(5GHz): +10dBm minimum

• 802.11ax HE160(5GHz): +10dBm minimum

Power Consumption • Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
 Idle mode 50 mW (WLAN unassociated)

• Connected Standby 10mW

Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ •802.11b, 1Mbps: -93.5dBm maximum

•802.11b, 11Mbps: -84dBm maximum • 802.11a/g, 6Mbps: -86dBm maximum • 802.11a/g, 54Mbps: -72dBm maximum • 802.11n, MCS07: -67dBm maximum • 802.11n, MCS15: -64dBm maximum

802.11ac, MCS0(VHT80): -84dBm maximum
802.11ac, MCS9(VHT80): -59dBm maximum
802.11ac, MCS9(VHT160): -58.5dBm maximum
802.11ax, MCS11(HE40): -57dBm maximum
802.11ax, MCS11(HE80): -54dBm maximum
802.11ax, MCS11(HE160): -53.5dBm maximum

Antenna Type High efficiency antenna with spatial diversity, mounted in the

display enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth

communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm

1. Type 2230 : 2.8q

Weight 1. Type 2230 : 2.8g 2. Type 1216: 1.3g

Operating Voltage 3.3v +/- 9%

Altitude

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)
Operating 10% to 90% (non-condensing)

Humidity Operating 10% to 90% (non-condensing Non-operating 5% to 95% (non-condensing)

Operating Non- 0 to 10,000 ft (3,048 m) operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio Off; LED Off – Radio ON

Technical Specifications - Networking

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Technology

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy: 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Data Rates and Throughput**

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps,

voice channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth

device with a maximum transmit power of + 9.5 dBm for BR and

EDR.

Peak (Tx): 330 mW **Power Consumption**

Peak (Rx): 230 mW

Selective Suspend: 17 mW

Bluetooth Software Supported

Link Topology

Microsoft Windows Bluetooth Software

Microsoft Windows ACPI, and USB Bus Support **Power Management**

FCC (47 CFR) Part 15C, Section 15.247 & 15.249 **Certifications**

Power Management ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 **Certifications**

UL, CSA, and CE Mark

Bluetooth® 4.1-ESR 5/6/7 Compliance **Bluetooth Profiles Supported**

> LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan Bluetooth® 4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Bluetooth®-5.2 ESR9/10 Compliance LE Advertisement Extensions **Channel Selection Algo**

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE LE Long Range Bluetooth® 5.3

Host to Controller Encryption Key Control Enahancements Compliance to the latest Errata Section 12.3 of Bluetooth® 5.3

wireless card specification



Technical Specifications – Networking

Wireless LAN Standards

Interoperability Frequency Band

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® AX211 Wi-Fi 6E +
Bluetooth® 5.3 wireless
card M.2 160MHz CNVi
World-wide WLAN
nonvPro® Wireless
Card1

IE	EEE 802	2.11a	
IE	EEE 802	2.11b	
IE	EEE 802	2.11g	
IE	EEE 802	2.11n	
IE	EEE 802	2.11ac	
IE	EEE 802	2.11ax	
IE	EEE 802	2.11d	
IE	EEE 802	2.11e	
IE	EEE 802	2.11h	
IE	EEE 802	2.11i	
IE	EEE 802	2.11k	
IE	EEE 802	2.11r	
IE	EEE 802	2.11v	
V	/i-Fi cer	tified	
8	02.11b	/g/n/ax	
•	2.402 -	-2.482	GHz
8	02.11a	/n/ac/a	<

4.9 – 4.95 GHz (Japan)
5.15 – 5.25 GHz
5.25 – 5.35 GHz

• 5.47 – 5.725 GHZ
• 5.825 – 5.850 GHz
• 5.955 – 6.415 GHz
• 6.435 – 6.515 GHz
• 6.535 – 6.875 GHz
• 6.895 – 7.115 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac: 1733Mbps802.11ax: max 2.4Gbps

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

, 1024QAM

Security¹ • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/q

mode only

• AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

Technical Specifications – Networking

WPA2 certification

WPA3 certification

• IEEE 802.11i

WAPI

Network Architecture Models Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +17dBm minimum

• 802.11g: +16dBm minimum • 802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
 802.11n HT40(2.4GHz): +13dBm minimum

• 802.11n HT20(5GHz): +14dBm minimum

• 802.11n HT40(5GHz): +13dBm minimum

802.11ac VHT80(5GHz): +10dBm minimum
 802.11ac VHT160(5GHz): +10dBm minimum

• 802.11ax HE40(2.4GHz): +12dBm minimum

• 802.11ax HE80(5GHz) : +10dBm minimum

802.11ax HE160(5GHz): +10dBm minimum

Power Consumption • Transmit mode 2.0 W

• Receive mode 1.6 W

• Idle mode (PSP) 180 mW (WLAN Associated)

• Idle mode 50 mW (WLAN unassociated)

• Connected Standby 10mW

Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ •802.11b, 1Mbps: -93.5dBm maximum

•802.11b, 11Mbps : -84dBm maximum • 802.11a/g, 6Mbps : -86dBm maximum • 802.11a/g, 54Mbps : -72dBm maximum

• 802.11a/g, 54Mbps : -72dBiff filaxilfidi • 802.11n, MCS07 : -67dBm maximum

• 802.11n, MCS15: -64dBm maximum

• 802.11ac, MCS0(VHT80) : -84dBm maximum

• 802.11ac, MCS9(VHT80): -59dBm maximum

• 802.11ac, MCS9(VHT160) : -58.5dBm maximum

•802.11ax, MCS11(HE40): -57dBm maximum

•802.11ax, MCS11(HE80): -54dBm maximum

•802.11ax, MCS11(HE160): -53.5dBm maximum

Antenna Type High efficiency antenna with spatial diversity, mounted in the

display enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth

communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230 : 2.8q

2. Type 1216: 1.3g

Operating Voltage 3.3v +/- 9%



Technical Specifications – Networking

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

HumidityOperating
Non-operating
10% to 90% (non-condensing)
5% to 95% (non-condensing)

Altitude Operating Non- 0 to 10,000 ft (3,048 m)

operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Technology

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy: 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

Data Rates and Throughput Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps,

voice channels

Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth

device with a maximum transmit power of + 9.5 dBm for BR and

EDR.

Power Consumption Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

Bluetooth Software Supported

Link Topology

Microsoft Windows Bluetooth Software

Power Management Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power ManagementETS 300 328, ETS 300 826CertificationsLow Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported Bluetooth® 4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan Bluetooth® 4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Bluetooth® 5.2



Technical Specifications – Networking

ESR9/10 Compliance
LE Advertisement Extensions
Channel Selection Algo
Limited High Duty Cycle Non-Connectable Advertising
2Mbps LE
LE Long Range
Bluetooth® 5.3
Host to Controller Encryption Key Control Enahancements
Compliance to the latest Errata Sectipn 12.3 of Bluetooth® 5.3
wireless card specification

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP 5G Sub-6 Cat 19 WWAN eSIM

Technology/Operating bands*

WCDMA/HSPA+ operating bands: Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)

Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)

Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

LTE FDD/TDD operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)

Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)

Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)

Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)

Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)

Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL)

Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL)

Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL)

Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL)

Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL)

Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL)

Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)

Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)

Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL)

Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)

Band 29: 717 to 728 MHz (DL)

Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)

Band 32: 1452 to 1496 MHz (DL)

Band 34: 2010 to 2025 MHz (UL/DL)

Band 38: 2570 to 2620 MHz (UL/DL)

Band 39: 1880 to 1920 MHz (UL/DL)



Technical Specifications – Networking

Band 40: 2300 to 2400 MHz (UL/DL) Band 41: 2496 to 2690 MHz (UL/DL) Band 42: 3400 to 3600 MHZ (UL/DL) Band 43: 3400 to 3800 MHZ (UL/DL) Band 46: 5150 to 5925 MHZ (DL) Band 48: 3550 to 3700 MHZ (UL/DL)

Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)

5GNR Sub 6GHZ

n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL) n30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)

n38: 2570 to 2620 MHz (UL/DL) n40: 2300 to 2400 MHz (UL/DL) n41: 2496 to 2690 MHz (UL/DL) n48: 3550 to 3700 MHZ (UL/DL)

n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)

n77: 3300 to 4200 MHz (UL/DL) n78: 3300 to 3800 MHz (UL/DL) n79: 4400 to 5000 MHz (UL/DL)

Wireless protocol standards

NR Sub6G rel15

200MHz 2 DLCA, 256 QAM 200MHz 2 ULCA, 256 QAM 15KHz/30KHz SCS for FDD/TDD

LTE Rel15

100MHz 5 DLCA, 256 QAM 40MHz 2 ULCA, 256 QAM

UMTS Rel8

GPS GPS only support L1 C/A **GPS bands** GPS: L1 (1575.42MHz)

GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz)

Maximum data rates

Sub-6 SA Peak
DL 4.67Gbps/UL 1.25Gbps

DL 4.07GUPS/UL 1.25GU

Sub-6 NSA Peak

DL 3.74Gbps/UL 835Mbps

LTE Peak

DL 1.6Gbps (CAT19)/UL 211Mbps (CAT18)

UMTS/HSPA+

DL DC-HSPA+: 42 Mbps (CAT24)/UL 11.5 Mbps (CAT7)

Maximum output power

NR:

23 dBm in all band except (n30 = 22dBm & n48=21dBm &

n77=25dBm & n41/n77/n78 = 26dBm)

LTE:



Technical Specifications - Networking

23 dBm in all band except (B30 = 22dBm & B48=21dBm &

B41=26dBm) UMTS: 23.5 dBm

Maximum power consumption

3500 mA (peak); 1674mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 8.7g

Dimensions 52 mm × 30 mm × 2.3 mm

(Length x Width x Thickness)

embedded eSIM Support

*5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

HP 4G LTE-A Pro Cat16 WWAN eSIM

Technology/Operating bands*

WCDMA/HSPA+ operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

LTE FDD/TDD operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) Band 4: 1710 to 1755 MHz (UL). 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL) Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL) Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL) Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL) Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL) Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL) Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL) Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)

Band 29: 717 to 728 MHz (DL)

Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)

Band 32: 1452 to 1496 MHz (DL) Band 34: 2010 to 2025 MHz (UL/DL) Band 38: 2570 to 2620 MHz (UL/DL) Band 39: 1880 to 1920 MHz (UL/DL) Band 40: 2300 to 2400 MHz (UL/DL)



Technical Specifications – Networking

Band 41: 2496 to 2690 MHz (UL/DL) Band 42: 3400 to 3600 MHZ (UL/DL) Band 43: 3400 to 3800 MHZ (UL/DL) Band 48: 3550 to 3700 MHZ (UL/DL)

Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)

Wireless protocol

standards

LTE Specification, 100MHz 5 DLCA, 256 QAM, DL 1.0Gbps (CAT16)/

40MHz 2 ULCA, 256 QAM, UL 211Mbps (CAT18)

WCDMA 3GPP Release 8 UMTS Specification, DL UMTS: 384 kbps/UL 384

kbp, DL DC-HSPA+: 42 Mbps (CAT24)/UL 11.5 Mbps (CAT7)

WCDMA R99,

3GPP LTE Rel15

3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone, A-GPS (MS-A, MS-B)

GPS Bands GPS: L1 (1575.42MHz)

GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz)

Maximum Data Rates

LTE: ue-CategoryDL 16, (DL: 1 Gbps)
ue-CategoryUL 18, (UL: 211Mbps)

DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload)

Maximum Output Power

HPUE: Not supported

LTE: 23 dBm in all band except (B30= 22dBm& B48= 21dBm)

UMTS: 23.5 dBm

Maximum Power Consumption

LTE: 1300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3052-S3 Key B

Weight 8 g

Dimensions 52 mm × 30 mm × 2.3 mm

(Length x Width x Thickness)

eSIM Support

*Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

NFC NXP NPC300

Dimensions (L x W

x H) 17 x 10 x 2.0 mm

Chipset NPC300 System interface I2C

NFC RF standards ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2



Technical Specifications – Networking

Reader (PCD-VCD)

ISO/IEC 14443 A Mode(1) ISO/IEC 14443 B

ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire

FeliCa

Jewel and Topaz cards

Card Emulation (PICC- ISO/IEC 14443 A

VICC) Mode(1)

ISO/IEC 14443 B and B'

MIFARE FeliCa

13.56 MHz **Frequency**

NFC Modes Supported Reader/Writer, Peer-to-Peer **Raw RF Data Rates** 106, 212, 424, 848 kbps

Operating

temperature Storage temperature -20°C to 125°C **Humidity**

0°C to 70°C 10-90% operating

5-95% non-operating

Supply Operating

voltage I/O Voltage 4.35 to 5.25 Volts 1.8V or 3.3V

Power Consumption

Booster enable.

 $VCC_BOOST = 5V$ **Mode Power** Consumption, **Typical**

Polling 7.3 mA

VBAT= 3.3V.

Detected Test Total 283.8 mA Tag Type 1 Net Module 236.8 mA Detected Test Total 288.8 mA Net Module 241.8 mA Tag Type 2 Detected Test Total 287.7 mA Tag Type 3 Net Module 240.7 mA

Detected Test Total 282.3 mA Tag Type 4 Net Module 235.3 mA

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

external to module.

Qualcomm® 9205

Technology/Operating bands*

FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 800 (Band 27), 700 (Band 28), 1700/2100 (Band 66), 700 (band 85) MHz.

GSM/GPRS/EGPRS: 850, 900, 1800, 1900MHz.

Wireless protocol standards

3GPP TS 51.010-1 V10.5.0: Mobile Station (MS) conformance

specification; Part 1: Conformance specification

• 3GPP TS 36.521-1 V14.3.0: User Equipment (UE) conformance specification; Radio transmission and reception; Part 1: Conformance testing

• 3GPP TS 21.111 V10.0.0: USIM and IC card requirements

3GPP TS 51.011 V4.15.0: Specification of the Subscriber Identity

Module -Mobile Equipment (SIM-ME) interface

3GPP TS 31.102 V10.11.0: Characteristics of the Universal Subscriber



Technical Specifications – Networking

Identity Module (USIM) application

3GPP TS 31.11 V10.16.0: Universal Subscriber Identity Module (USIM)

Application Toolkit (USAT)

• 3GPP TS 36.124 V10.3.0: Electro Magnetic Compatibility (EMC) requirements for mobile terminals and ancillary equipment

3GPP TS 27.007 V10.0.8: AT command set for User Equipment (UE)
 3GPP TS 27.005 V10.0.1: Use of Data Terminal Equipment - Data Circuit terminating Equipment (DTE - DCE) interface for Short Message Service

(SMS) and Cell Broadcast Service (CBS)

GPS Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)

GPS Bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098

MHz

Maximum Data Rates LTE FDD: 375 Kbps (Download), 1119 Kbps (Upload)

GSM:

- GPRS: 107 Kbps (Download), 85.6 Kbps (Upload) - EGPRS: 296 Kbps (Download), 236.8 Kbps (Upload)

Maximum Output Power LTE: 21.5 dBm in all band

GSM:34dBm

Maximum PowerLTE: 1,200 mA (peak); 900 mA (average)ConsumptionHSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 2242-S3 Key B

Weight 5.5 q

Dimensions 22 x 42 x 2.3 mm

(Length x Width x Thickness)

eSIM Support

11. LPWAN (also called Mobile Narrowband) does not support mobile broadband use.

AUDIO

HD Stereo Codec Realtek ALC3315

Audio I/O Ports Headset: CTIA only and Headphone-out

Internal Speaker

Amplifier Cirrus Logic High-Efficiency Boosted Class D Amplifier

Multi-streaming Capable Playback multi-streaming can be enabled in the audio control panel to allow independent audio.

Following MSFT Behaviour

Sampling DAC:48kHz

ADC:48kHz

Wavetable Syntheses N/A

Analog Audio Support 3.5mm Headset: CTIA only and Headphone-out

of Channels on Line-

N/A

Internal Speaker Yes

FINGERPRINT READER



Out

Technical Specifications - Networking

Sensor vendor Synaptics
Sensor type Capacitive
DPI resolution 363 DPI

Scan area104 x 86 pixelsFalse Rejection RateFRR=≤ 3%False Acceptance RateFAR 1/100KMobile Voltage Operation3.0V to 3.6VOperating Temperature0~60C

Current Consumption

Image

100mA max

Low Latency Wait For

Finger

260uA

Capture Rate 50 Frames/ sec

ESD Resistance IEC 61000-4-2 4B (+15KV) **Detection Matrix** 363 dpi / 7.4x6mm sensor area

Sensor vendorElanSensor typeCapacitiveDPI resolution508 DPIScan area80 x 80 pixelsFalse Rejection RateFRR=≤ 3%False Acceptance RateFAR 1/100KMobile Voltage Operation2.7V to 3.6VOperating Temperature-20~80C

Current Consumption

Image

35mA max

Low Latency Wait For

Finger

300uA

Capture Rate 50 Frames/ sec

ESD Resistance IEC 61000-4-2 4B (+15KV)

Detection Matrix 508 dpi / 4.0x1.0mm sensor area

Input

POWER

AC Adapter 65 Watt nPFC Dimensions 3.543 x 2.008 x 1.122 in (9.0x5.1x2.85cm)

Standard USB type C

Straight 1.8m

Weight 240g ± 10g

Input Efficiency 81.50% min at 115 Vac/ 230 Vac @5.00V

86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.6 A at 90 Vac

Output Output power 5V/15W

9V/27W 12V/60W 15V/65W



Technical Specifications - Networking

20V/65W

DC output 5V/9V/12V/15V/20V

Hold-up time 100% load 5ms at 115 Vac input

Output current limit <8.0A AC Inlet Type C6

DC Cable Connector USB type C
DC Cable Material PVC

Connector C6

Environmental Design Operating

temperature 32° to 95° F (0° to 35° C)

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity20% to 95%Storage Humidity10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950-1 and IEC62368-1: 2018,

EN62368-1:2014+A11, UL 62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-

mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC

HP 65W Slim USB-C Straight AC Power Adapter

Dimensions Weight

Input

Output

3.819 x 2.106 x 0.827 in (9.7x5.35x2.1cm)

220g ± 10g

Input Efficiency

81.50% min at 115 Vac/ 230 Vac @5.00V 86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V

Input frequency range 47-63Hz

Input AC current Max. 1.6 A at 90 Vac

Output power 5V/15W

9V/27W 12V/60W 15V/65W 20V/65W

DC output 5V/9V/12V/15V/20V

Hold-up time 100% load 5ms at 115 Vac input

Output current limit < 8.0A AC Inlet Type C6

DC Cable Connector USB type C **DC Cable Material** PVC

Connector C6

Environmental Design Operating temperature

32° to 95° F (0° to 35° C)

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Technical Specifications – Networking

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950-1 and IEC62368-1: 2018,

EN62368-1:2014+A11, UL 62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-

mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC

HP 100W Slim USB-C Straight AC Power Adapter Dimensions Weight

Input

Output

5.354 x 2.362 x 0.866 in (13.6x6.0x2.2cm)

380g ± 10g

Input Efficiency 81.50% min at 115 Vac/ 230 Vac @5.00V

86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V

Input frequency range 47-63Hz

Input AC current Max. 1.6 A at 90 Vac

Output power 5V/15W

9V/27W 12V/60W 15V/75W 20V/100W

DC output 5V/9V/12V/15V/20V

Hold-up time 100% load 5ms at 115 Vac input/80% load

10ms at 115 Vac input

Output current limit 5V/9V/12V/15V<125% max current, 20V<135%

max current

AC Inlet Type C6

DC Cable Connector USB type C **DC Cable Material** PVC

Connector C6

Environmental Design

Operating 32° to 95° F (0° to 35° C)

temperature

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity20% to 95%Storage Humidity10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950-1, IEC 62368-1:2014 and

IEC62368-1:2018, EN62368-1:2020+A11, UL 62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, CU(EAC), KCC(Safety+EMC), NOM-001 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia RCM, BIS, BSMI, UAE, UKCA

DoC, Ukraine(CoC+DoC+RoHS+ECO)

Technical Specifications - Networking

HP 3-cell Long Life Li-Ion Dimensions (H x W x L) 251.8*70.3*6.82mm (9.91*2.77*0.27 inch)

(56 WHr) Weight 0.205kg +/- 10g(0.474 lb)

Cells/Type3cell Lithium-Ion Polymer cell / 586075EnergyVoltage11.58V

Amp-hour capacity 4.84Ah Watt-hour capacity 56.04Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 140° F (-10° to 60° C)

Fuel Gauge LED NA

Warranty Follow product spec

Optional Travel Battery

Available

No

*Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.



Technical Specifications - Environmental

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT[®] Gold registered in the United States. See http://www.epeat.net for registration status in your country.
- TCO Certified
- China Energy Conservation Program (CECP)
- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label*

Sustainable Impact Specifications

- Product Carbon Footprint (hp.com)
- · Ocean-bound plastic in Speaker
- 60% post-consumer recycled plastic
- 65% recycled metal
- Low halogen
- Outside Box and corrugated cushions are 100% sustainably sourced and recyclable
- Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable
- · Bulk packaging available

115VAC 60H2

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

23UNAC 5UH2

Energy Consumption (in accordance with US ENERGY STAR® test method)

STAR' (est illetilou)	I I SVAC, OUNZ	ZOVAC, JUNZ	TOUVAC, SUNZ
Normal Operation (Short idle)	5.88 W	6.17 W	5.92 W
Normal Operation (Long idle)	1.66 W	1.85 W	1.76 W
Sleep	1.66 W	1.85 W	1.76 W
Off	0.46 W	0.48 W	0.41 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	20.1 BTU/hr	21.1 BTU/hr	20.2 BTU/hr
Normal Operation (Long idle)	5.7 BTU/hr	6.3 BTU/hr	6.0 BTU/hr
Sleep	5.7 BTU/hr	6.3 BTU/hr	6.0 BTU/hr
Off	1.6 BTU/hr	1.6 BTU/hr	1.4 BTU/hr



100VAC 50Hz

Technical Specifications – Environmental

***NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions	Sound Power	Sound Pressure
(in accordance with	(L _{wad} , bels)	(L _{pAm} , decibels)
ISO 7779 and ISO 9296)		
Typically Configured – Idle	3.1	20.6
Fixed Disk – Random writes	3.3	22.8
Optical Drive – Sequential reads	4.0	31.5

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive – 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 94% recycle-able when properly disposed of at end of life.

Packaging Materials	External:	PAPER/Corrugated	220 g
		PAPER/Corrugated	49 g
		PAPER/Molded Pulp	52 g
		PAPER/Molded Pulp	56 g
		PAPER/Paper	3 g
	Internal:	PLASTIC/Polyethylene low density - LDPE	13 g

The plastic packaging material contains at least 0.0% recycled content.

The corrugated paper packaging materials contains at least 59.1% recycled content.

RoHS Compliance

HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

Technical Specifications – Environmental

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.



Technical Specifications – Environmental

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842

nd

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

Footnotes

- Percentage of ocean-bound plastic contained in each component varies by product
- Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.
- External power supplies, WWAN modules, power cords, cables and peripherals excluded.
- 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.
- Fiber cushions made from 100% recycled wood fiber and organic materials.
- Plastic cushions are made from >90% recycled plastic.



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Audio/Video	HP USB G2 Stereo Headset	428H5AA
	HP USB G2 Stereo Headset	428K6AA
	HP 3.5mm G2 Stereo Headset	428H6AA
	HP 3.5mm G2 Stereo Headset	428K7AA
	HP 365 BT Speaker	567D3AA
	HP 325 FHD USB-A Webcam	53X27AA
	HP 965 4K Streaming Webcam	695J5AA
	HP 625 FHD Webcam	6Y7L1AA
Cases	HP Prelude 15.6 Backpack (Bulk Qty.15)	1E7D6A6
	HP Prelude Pro Recycle Backpack	1X644AA
	HP Prelude Pro Recycle Top Load	1X645AA
	HP Prelude 15.6 Top Load	1E7D7AA
	HP Prelude 15.6 Top Load	2Z8P4AA
	HP Prelude 15.6 Top Load	50P31AA
	HP Prelude 15.6 Backpack	1E7D6AA
	HP Prelude 15.6 Backpack	2Z8P3AA
	HP Prelude 15.6 Backpack	50P32AA
	HP Prelude Pro Recycled 15.6 Backpack (Bulk Qty.12)	1X644A6
	HP Prelude Pro Recycled 15.6 Top Load (Bulk Qty.12)	1X645A6
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 17.3 Laptop Backpack (Bulk Qty. 6)	3E2U5A6
	HP Renew Business 15.6 Laptop Bag (Bulk Qty.12)	3E5F8A6
	HP Renew Business 14.1 Laptop Bag (Bulk Qty.12)	3E5F9A6
	HP Renew Business 14.1 Sleeve (Bulk Qty. 24)	3E2U7A6
	HP Renew Executive 16 Laptop Backpack	6B8Y1AA
	HP Renew Executive 16 Laptop Bag	6B8Y2AA
	HP Renew Executive 14.1 Laptop Sleeve	6B8Y3AA
	HP Travel 25 Liter 15.6 Iron Gray Laptop Backpack	6B8U4AA
	HP Travel 25 Liter 15.6 Iron Gray Laptop Backpack	6H2D8AA
	HP Travel 18 Liter 15.6 Iron Gray Laptop Backpack	6B8U6AA
	HP Travel 18 Liter 15.6 Iron Gray Laptop Backpack	6H2D9AA
Docking station	HP USB-C Dock G5	26D32AA
	HP USB-C Dock G5	5TW10AA
	HP USB-C/A Universal Dock G2	5TW13AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 280W G4 Dock w/Combo Cable	4J0G4AA
	HP USB-C G5 Essential Dock	72C71AA



Options and Accessories (sold separately and availability may vary by country)

Donalo	UD UDMI to VCA Adaptor		H4F02AA
Dongle	HP HDMI to VGA Adapter HP USB-C to USB 3.0 Adapter		N2Z63AA
	·		N9K78AA
	HP USB-C to DisplayPort Adapter HP USB-C to VGA Adapter		N9K76AA
	HP USB-C to VGA Adapter		P7Z54AA
	HP USB-C to HDMI 2.0 Adapter		1WC36AA
	HP USB-C to HDMI 2.0 Adapter		2PC54AA
	HP USB-C to RJ45 Adapter G2		4Z527AA
	HP USB-C to RJ45 Adapter G2		4Z534AA
	HP USB 3.0 to Gig RJ45 Adapter G2		4Z7Z7AA
	HP USB-C to DisplayPort Adapter G2		8Y8Y1AA
	TIF 03b-C to Displayr of Chapter 42		OTOTIAA
Hub	HP USB-C Travel Hub G2		7PJ38AA
	HP USB-C to USB-A Hub		Z6A00AA
	HP Universal USB-C Multiport Hub		50H55AA
	HP Universal USB-C Multiport Hub		50H98AA
	HP 4K USB-C Multiport Hub		6G842AA
	HP 4K USB-C Multiport Hub		6G843AA
	HP Universal USB-C Hub and Laptop Charger Combo	•	9Н0Н9АА
Keyboard/Combo	HP 320K Wired Keyboard		9SR37AA
	HP 975 USB+BT Dual-Mode Wireless Keyboard		3Z726AA
	HP 455 Programmable Wireless Keyboard		4R177AA
	HP 965 BLK Ergonomic Wireless Keyboard		7E756AA
	HP 475 Dual-Mode Wireless Keyboard	•	7N7B9AA
	HP 405 Multi-Device Backlit Wired Keyboard		7N7C1AA
	HP 435 Programmable Bluetooth Wireless Keypad		7N7C3AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	:	3M165AA
	HP Wired Desktop 320MK Mouse and Keyboard		9SR36AA
	HP 655 Wireless Keyboard and Mouse Combo		4R009AA
Mouse	HP Wired 320M Mouse		9VA80AA
	HP Premium Wireless Mouse		1JR31AA
	HP Travel Bluetooth Mouse		6SP30AA
	HP Multi-Device 635 Black Wireless Mouse		1D0K2AA
	HP Creator 935 Black Wireless Mouse		1D0K8AA
	HP 235 Slim Wireless Mouse		4E407AA
	HP 435 Multi-Device Wireless Mouse		3B4Q5AA
	HP 715 Rechargeable Multi-Device Bluetooth Mouse		6E6F0AA
	HP 925 Ergonomic Vertical Wireless Mouse		6H1A5AA
Power	HP 65W USB-C LC Power Adapter		1P3K6AA
	HP 65W USB-C LC Power Adapter		944V0AA
			



Options and Accessories (sold separately and availability may vary by country)

	HP 65W Gallium Nitride USB-C Laptop Charger	600Q7AA
	HP 65W Gallium Nitride USB-C Laptop Charger	600Q7AA
	HP 65W USB-C Laptop Charger	671R2AA
	HP 65W USB-C Laptop Charger	671R3AA
	HP 110W USB-C Laptop Charger	8B3Y2AA
	The Frow OSB C Emptop charger	ODSTEAM
Commodity	HP 2TB PCIe-4x4 NVMe TLC M.2 Solid State Drive	6D8L6AA
	HP USB External DVDRW Drive	F2B56AA
	HP USB External DVDRW Drive	Y3T76AA
Security	HP Nano Keyed Cable Lock	1AJ39AA
•	HP Nano Keyed Cable Lock	1AJ39UT
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP Sure Key Cable Lock	6UW42AA
	HP Nano Combination Cable Lock	63B28AA
	HP Essential Nano Combination Cable Lock	63B31AA
Monitor	HP Z38c 37.5-inch Curved Display	Z4W65A4
	HP Z38c 37.5-inch Curved Display	Z4W65A7
	HP Z38c 37.5-inch Curved Display	Z4W65A8
	HP Z38c 37.5-inch Curved Display	Z4W65AT
	HP Z27k G3 4K USB-C Display	1B9T0A7
	HP Z27k G3 4K USB-C Display	1B9T0AA
	HP Z27k G3 4K USB-C Display	1B9T0AT
	HP Z27u G3 QHD USB-C Display	1B9X2A7
	HP Z27u G3 QHD USB-C Display	1B9X2AA
	HP Z27u G3 QHD USB-C Display	1B9X2AT
	HP Z24u G3 WUXGA USB-C Display	1C4Z6A7
	HP Z24u G3 WUXGA USB-C Display	1C4Z6AA
	HP Z24u G3 WUXGA USB-C Display	1C4Z6AT
	HP Z24u G3 WUXGA USB-C Display	1C4Z6E9
	HP Z24q G3 QHD Display	4Q8N4A7
	HP Z24q G3 QHD Display	4Q8N4AA
	HP Z24q G3 QHD Display	4Q8N4AT
	HP Z24q G3 QHD Display	4Q8N4E9
	HP Z24m G3 QHD Conferencing Display	4Q8N9A7
	HP Z24m G3 QHD Conferencing Display	4Q8N9AA
	HP Z24m G3 QHD Conferencing Display	4Q8N9AT
	HP Z24m G3 QHD Conferencing Display	4Q8N9E9
	HP Z32k G3 4K USB-C Display	50U19A7
	HP Z32k G3 4K USB-C Display	50U19AA
	HP Z32k G3 4K USB-C Display	50U19AT
	HP Z32k G3 4K USB-C Display	50U19E9



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Date of change:	Version History:		Description of change:
March 12, 2024	From v1 to v2	Changed	POWER section
March 25, 2024	From v2 to v3	Changed	Page 1 Right image
April 8, 2024	From v3 to v4	Changed	Format
April 24, 2024	From v4 to v5	Changed	WEIGHTS & DIMENSIONS, POWER sections

